PKU 5000E series	EN/LZT 146 391 R4B May 2009
DC/DC converters, Input 18-72 V, Output up to 10 A/35 W	© Ericsson AB

Key Features

- Industry standard Sixteenth-brick 33.02 x 22.86 x 7.50 mm (1.3 x 0.9 x 0.295 in.)
- Wide Input range 18-72 Vin
- High efficiency, typ. 91.7 % at 5 V half load & 27 V_{in}
- 1500 V_{dc} input to output isolation
- Surface mount option
- Meets safety requirements according to IEC/EN/UL 60950
- More than 1.71 million hours MTBF

General Characteristics

- Input under voltage protection
- Over temperature protection
- Output over voltage protection
- Output short circuit protection
- Remote control
- · Highly automated manufacturing ensures quality
- ISO 9001/14001 certified supplier

Safety Approvals

113613

Design for Environment Pb ROHS compliant

Meets requirements in high-temperature lead-free soldering processes.

Contents

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PKU 5000E series EN/LZT 146 39 DC/DC converters, Input 18-72 V, Output up to 10 A/35 W © Ericsson AB

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General Information

Ordering Information

See Contents for individual product ordering numbers.

Option	Suffix	Ordering No.
Surface mount	SI	PKU 5310E SI
Positive Remote Control Logic	Р	PKU 5310E PIP
Lead length 3.69 mm (0.145 in)	LA	PKU 5310E PILA
Lead length 4.57 mm (0.180 in)	LB	PKU 5310E PILB
Lead length 5,33 mm (0.210 in)	PI	PKU 5310E PI
Note 1: If several options needed below	<i>w</i> sequence	is to be used: Positive

logic option, LA length. Example: PKU 5310E PIPLA

Reliability

The Mean Time Between Failure (MTBF) is calculated at full output power and an operating ambient temperature (T_A) of +40°C. Different methods could be used to calculate the predicted MTBF and failure rate which may give different results. Ericsson Power Modules currently uses two different methods, Ericsson failure rate data system DependTool and Telcordia SR332.

Predicted MTBF for the series is:

1.71million hours according to Telcordia SR332, issue 1, Black box technique.

The Ericsson failure rate data system is based on field tracking data. The data corresponds to actual failure rates of components used in Information Technology and Telecom (IT&T) equipment in temperature controlled environments($T_A = -5...+65^{\circ}C$). Telcordia SR332 is a commonly used standard method intended for reliability calculations in IT&T equipment. The parts count procedure used in this method was originally modelled on the methods from MIL-HDBK-217F, Reliability Predictions of Electronic Equipment. It assumes that no reliability data is available on the actual units and devices for which the predictions are to be made, i.e. all predictions are based on generic reliability parameters.

Compatibility with RoHS requirements

The products are compatible with the relevant clauses and requirements of the RoHS directive 2002/95/EC and have a maximum concentration value of 0.1% by weight in homogeneous materials for lead, mercury, hexavalent chromium, PBB and PBDE and of 0.01% by weight in homogeneous materials for cadmium.

Exemptions in the RoHS directive utilized in Ericsson AB products include:

- Lead in high melting temperature type solder (used to solder the die in semiconductor packages)
- Lead in glass of electronics components and in electronic ceramic parts (e.g. fill material in chip resistors)
- Lead as an alloying element in copper alloy containing up to 4% lead by weight (used in connection pins made of Brass)

Quality Statement

The products are designed and manufactured in an industrial environment where quality systems and methods like ISO 9000, 6σ (sigma), and SPC are intensively in use to boost the continuous improvements strategy. Infant mortality or early failures in the products are screened out and they are subjected to an ATE-based final test. Conservative design rules, design reviews and product qualifications, plus the high competence of an engaged work force, contribute to the high quality of our products.

Warranty

Warranty period and conditions are defined in Ericsson AB General Terms and Conditions of Sale.

Limitation of Liability

Ericsson AB does not make any other warranties, expressed or implied including any warranty of merchantability or fitness for a particular purpose (including, but not limited to, use in life support applications, where malfunctions of product can cause injury to a person's health or life).

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DC/DC converters, Input 18-72 V, Output up to 10 A/35 W	© Ericsson AB

Safety Specification

General information

Ericsson AB DC/DC converters and DC/DC regulators are designed in accordance with safety standards IEC/EN/UL60950, *Safety of Information Technology Equipment*.

IEC/EN/UL60950 contains requirements to prevent injury or damage due to the following hazards:

- Electrical shock
- Energy hazards
- Fire
- Mechanical and heat hazards
- Radiation hazards
- Chemical hazards

On-board DC-DC converters are defined as component power supplies. As components they cannot fully comply with the provisions of any Safety requirements without "Conditions of Acceptability". It is the responsibility of the installer to ensure that the final product housing these components complies with the requirements of all applicable Safety standards and Directives for the final product.

Component power supplies for general use should comply with the requirements in IEC60950, EN60950 and UL60950 "Safety of information technology equipment".

There are other more product related standards, e.g. EC61204-7 "Safety standard for power supplies", IEEE802.3af "Ethernet LAN/MAN Data terminal equipment power", and ETS300132-2 "Power supply interface at the input to telecommunications equipment; part 2: DC", but all of these standards are based on IEC/EN/UL60950 with regards to safety.

Ericsson AB DC/DC converters and DC/DC regulators are UL60950 recognized and certified in accordance with EN60950.

The flammability rating for all construction parts of the products meets requirements for V-0 class material according to IEC 60695-11-10.

The products should be installed in the end-use equipment, in accordance with the requirements of the ultimate application. Normally the output of the DC/DC converter is considered as SELV (Safety Extra Low Voltage) and the input source must be isolated by minimum Double or Reinforced Insulation from the primary circuit (AC mains) in accordance with IEC/EN/UL60950.

Isolated DC/DC converters

It is recommended that a slow blow fuse with a rating twice the maximum input current per selected product be used at the input of each DC/DC converter. If an input filter is used in the circuit the fuse should be placed in front of the input filter.

In the rare event of a component problem in the input filter or in the DC/DC converter that imposes a short circuit on the input source, this fuse will provide the following functions:

- Isolate the faulty DC/DC converter from the input power source so as not to affect the operation of other parts of the system.
- Protect the distribution wiring from excessive current and power loss thus preventing hazardous overheating.

The galvanic isolation is verified in an electric strength test. The test voltage (V_{iso}) between input and output is 1500 Vdc or 2250 Vdc for 60 seconds (refer to refer to Absolute maximum ratings). Leakage current is less than 100 µA at nominal input

Leakage current is less than 100 µA at nominal input voltage.

24 V DC systems

The input voltage to the DC/DC converter is SELV (Safety Extra Low Voltage) and the output remains SELV under normal and abnormal operating conditions.

48 and 60 V DC systems

If the input voltage to Ericsson AB DC/DC converter is 75 Vdc or less, then the output remains SELV (Safety Extra Low Voltage) under normal and abnormal operating conditions.

Single fault testing in the input power supply circuit should be performed with the DC/DC converter connected to demonstrate that the input voltage does not exceed 75 Vdc.

If the input power source circuit is a DC power system, the source may be treated as a TNV2 circuit and testing has demonstrated compliance with SELV limits and isolation requirements equivalent to Basic Insulation in accordance with IEC/EN/UL60950.

Non-isolated DC/DC regulators

The input voltage to the DC/DC regulator is SELV (Safety Extra Low Voltage) and the output remains SELV under normal and abnormal operating conditions.

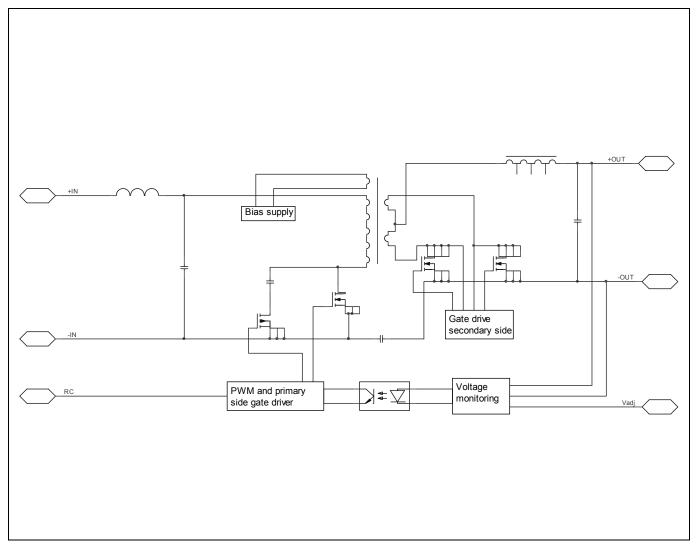
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DC/DC converters, Input 18-72 V, Output up to 10 A/35 W	© Ericsson AB	

Absolute Maximum Ratings

Chara	Characteristics			typ	max	Unit
T_{P1}	Operating Temperature (see Thermal Consideration section)	-40		+105	°C
Ts	Storage temperature		-55		+100	°C
VI	Input voltage		-0.5		+80	V
V_{iso}	Isolation voltage (input to output test voltage)				1500	Vdc
V _{tr}	Input voltage transient (t _p 100 ms)				100	V
V _{RC}	Remote Control pin voltage	Positive logic option	-0.5		40	V
v _{RC} (s	(see Operating Information section) Negative logic option		-0.5		40	V
V_{adj}	Adjust pin voltage (see Operating Information section)		-0.5		$2 x V_{oi}$	V

Stress in excess of Absolute Maximum Ratings may cause permanent damage. Absolute Maximum Ratings, sometimes referred to as no destruction limits, are normally tested with one parameter at a time exceeding the limits of Output data or Electrical Characteristics. If exposed to stress above these limits, function and performance may degrade in an unspecified manner.

Fundamental Circuit Diagram



PKU 5000E series

DC/DC converters, Input 18-72 V, Output up to 10 A/35 W

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3.3 V/10 A Electrical Specification

 T_{P1} = -30 to +90°C, V_I = 18 to 72 V, unless otherwise specified under Conditions. Typical values given at: T_{P1} = +25°C, V_I = 53 V_I max I₀, unless otherwise specified under Conditions. Additional C₀ = 220 µF

Chara	cteristics	Conditions	min	typ	max	Unit
Vı	Input voltage range		18		72	V
V _{loff}	Turn-off input voltage	Decreasing input voltage	15	16	17	V
Vlon	Turn-on input voltage	Increasing input voltage	16	17	18	V
Cı	Internal input capacitance			4.4		μF
Po	Output power	Output voltage initial setting	0		33	W
	F #isianau	50 % of max I _{O,} , V _I = 27 V		89.4		
n		max I _{O,} , V ₁ = 27 V		89.2		%
η	Efficiency	50 % of max I _o , V _I = 53 V		87.3		
		max I ₀ , V ₁ = 53 V		88.1		
Pd	Power Dissipation	max I _o		4.4	7.5	W
Pli	Input idling power	I ₀ = 0 A, V ₁ = 53 V		1.8		W
P _{RC}	Input standby power	V ₁ = 53 V (turned off with RC)		0.65		W
f _s	Switching frequency	0-100 % of max I _o	255	285	315	kHz

V _{Oi}	Output voltage initial setting and accuracy	T_{P1} = +25°C, V _I = 53 V, I _O = 10 A	3.24	3.30	3.36	V
	Output adjust range	See operating information	2.97		3.63	V
	Output voltage tolerance band	10-100 % of max I _o	3.20		3.40	V
Vo	Idling voltage	I _O = 0 A	3.24		3.36	V
	Line regulation	max I _o		±5	±25	mV
	Load regulation	V_{I} = 53 V, 0-100 % of max I_{O}		±5	±25	mV
V _{tr}	Load transient voltage deviation	V₁ = 53 V, Load step 25-75-25 % of max I₀, di/dt = 5 A/µs C₀ = 1mF		±250	±400	mV
t _{tr}	Load transient recovery time	$\max_{i_0} a_i a_i = 5 \text{ Arps } C_0 = \min_{i_0} a_i a_i$		250	400	μs
t _r	Ramp-up time (from 10-90 % of V _{Oi})	10-100 % of max lo		7		ms
ts	Start-up time (from V _I connection to 90 % of V _{Oi})	10-100 % of max 1 ₀		8		ms
t _f	V_1 shut-down fall time (from V_1 off to 10 % of V_0)	max I _o		2		mS
ч		$I_{O} = 0 A$		15		S
	RC start-up time	max I _o		8		ms
t _{RC}	RC shut-down fall time	max I _o		0.35		ms
	(from RC off to 10 % of V_{o})	I ₀ = 0 A		15		S
lo	Output current		0		10	А
l _{lim}	Current limit threshold	V _I = 53 V, T _{P1} < max T _{P1}		15	20	А
I _{sc}	Short circuit current	T _{P1} = 25°C, Note 1		18		А
V _{Oac}	Output ripple & noise	See ripple & noise section, max I_0 , V_{0i} , C_0 = 220uF		45	80	mVp-p
OVP	Over voltage protection	T_{P1} = +25°C, V _I = 53 V, 0-100 % of max I ₀		3.9		V

PKU 5310E PI

DC/DC converters, Input 18-72 V, Output up to 10 A/35 W

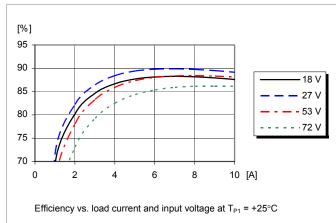
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Technical Specification

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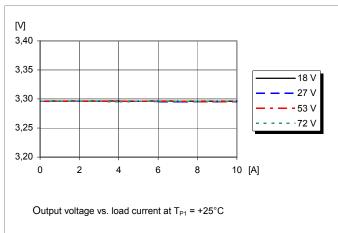
3.3 V/10 A Typical Characteristics

Efficiency



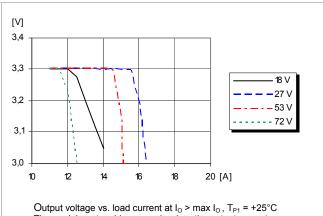
[W] 10 8 18 V 6 27 \ 53 V 4 72 2 0 6 8 0 2 4 10 [A] Dissipated power vs. load current and input voltage at T_{P1} = +25 $^{\circ}\text{C}$

Output Characteristics



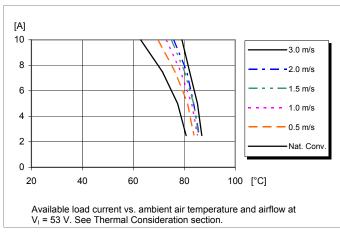
Current Limit Characteristics

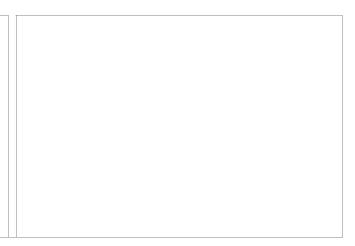
Power Dissipation



The module enters hiccup mode when the output current exceeds current limit.

Output Current Derating





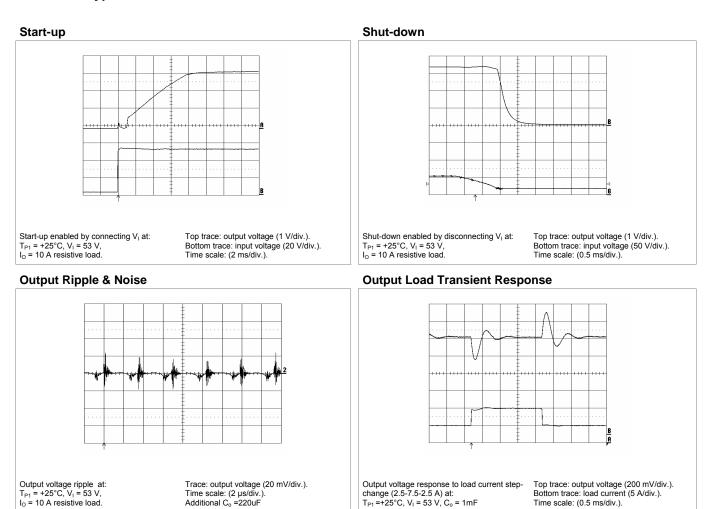
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3.3 V/10 A Typical Characteristics

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Output Voltage Adjust (see operating information)

Passive adjust

The resistor value for an adjusted output voltage is calculated by using the following equations:

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Output Voltage Adjust Upwards, Increase:
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Radi -	$(5.11 \times 3.30(100 + \Delta\%))$	511 10 22	kO
Kaay –	1.225×∆%	$\frac{1}{\Delta\%}$ = 10.22	K22

Example: Increase 4% =>V_{out} = 3.432 Vdc $\left(\frac{5.11 \times 3.30(100 + 4)}{1.225 \times 4} - \frac{511}{4} - 10.22\right)$ k Ω = 220 k Ω

Active adjust

The output voltage may be adjusted using a voltage applied to the Vadj pin. This voltage is calculated by using the following equations:

$$Vadj = \left(1.225 + 2.45 \times \frac{Vdesired - 3.30}{3.30}\right) \vee$$

Example: Upwards => 3.50 V

$$\left(1.225 + 2.45 \times \frac{3.50 - 3.30}{3.30}\right) V = 1.37 V$$

PKU 5000E series

DC/DC converters, Input 18-72 V, Output up to 10 A/35 W

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5 V/7 A Electrical Specification

 T_{P1} = -30 to +90°C, V_{I} = 18 to 72 V, unless otherwise specified under Conditions. Typical values given at: T_{P1} = +25°C, V_{I} = 53 V_{I} max I_{O} , unless otherwise specified under Conditions. Additional C_{o} = 150 μF .

Chara	cteristics	Conditions	min	typ	max	Unit
Vı	Input voltage range		18		72	V
V _{loff}	Turn-off input voltage	Decreasing input voltage	15	16	17	V
V _{Ion}	Turn-on input voltage	Increasing input voltage	16	17	18	V
Cı	Internal input capacitance			4.4		μF
Po	Output power	Output voltage initial setting	0		35	W
	Efficiency	50 % of max I _o , V _I = 27 V		91.7		
n		max I ₀ , V _I = 27 V		91.0		~ %
"		50 % of max I_0 , V_1 = 53 V		89.4		
		max I _o , V _I = 53 V		90.5		
P _d	Power Dissipation	max I _o		3.8	5.6	W
Pli	Input idling power	I ₀ = 0 A, V ₁ = 53 V		1.6		W
P _{RC}	Input standby power	V ₁ = 53 V (turned off with RC)		0.5		W
f _s	Switching frequency	0-100 % of max $I_{\rm O}$	255	285	315	kHz

V _{Oi}	Output voltage initial setting and accuracy	T _{P1} = +25°C, V _I = 53 V, I _O = 7 A	4.9	5	5.1	V
	Output adjust range	See operating information	4.5		5.5	V
	Output voltage tolerance band	10-100 % of max I _o	4.85		5.15	V
Vo	Idling voltage	I ₀ = 0 A	4.9		5.1	V
	Line regulation	max I _o		±5	±25	mV
	Load regulation	V_{I} = 53 V, 0-100 % of max I_{O}		±5	±25	mV
/ _{tr}	Load transient voltage deviation	$V_1 = 53 V$, Load step 25-75-25 % of		±300	±500	mV
tr	Load transient recovery time	max I _o , di/dt = 5 A/ μ s, C _o = 700 μ F		250	400	μs
r	Ramp-up time (from 10–90 % of V _{Oi})	10-100 % of max Io		5.0	15	ms
s	Start-up time (from V ₁ connection to 90 % of V _{Oi})			6.5	20	ms
f	V _I shut-down fall time	max I ₀	0.2	2		ms
T	(from V ₁ off to 10 % of V ₀)	$I_{O} = 0 A$		1.4		S
	RC start-up time	max I _o		7.0		ms
RC	RC shut-down fall time	max I _o	0.2	0.4		ms
	(from RC off to 10 % of V_0)	I ₀ = 0 A		2.3		s
0	Output current		0		7	А
lim	Current limit threshold	V _I = 53 V, T _{P1} < max T _{P1}		11	14.5	А
sc	Short circuit current	T _{P1} = 25°C, Note 1		12		А
/ _{Oac}	Output ripple & noise	See ripple & noise section, max I_0 , V_{0i} , C_0 = 220 μ F		25	60	mVp-p
OVP	Over voltage protection	T_{P1} = +25°C, V _I = 53 V, 0-100 % of max I ₀		7		V

1) RMS value

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DC/DC converters, Input 18-72 V, Output up to 10 A/35 W

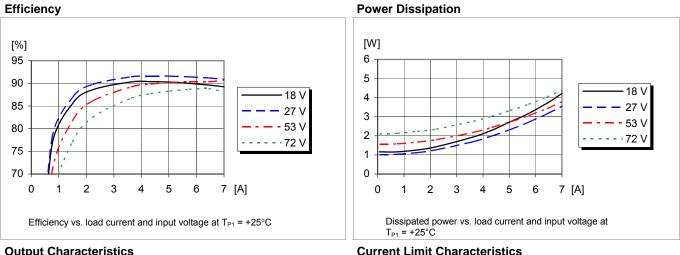
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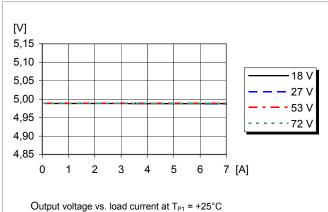
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5 V/7 A Typical Characteristics

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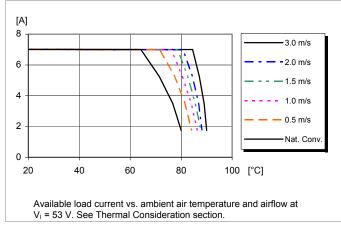
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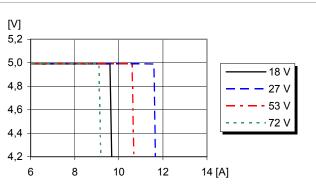


Output Characteristics

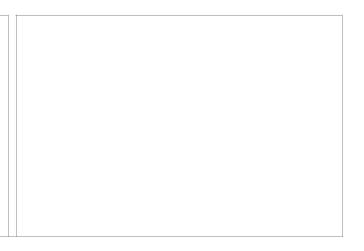




Current Limit Characteristics



Output voltage vs. load current at I_0 > max I_0 , T_{P1} = +25°C The module enters hiccup mode when the output current exceeds current limit.



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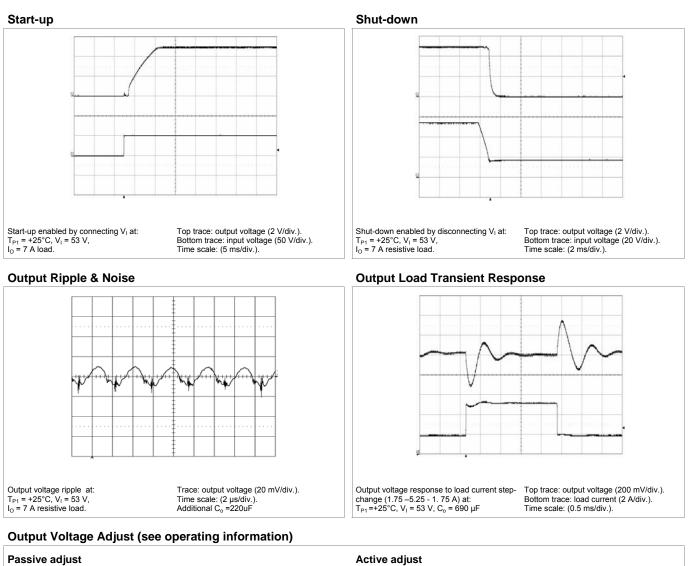
5 V/7 A Typical Characteristics

PKU 5311E PI

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The resistor value for an adjusted output voltage is calculated by using the following equations:

Output Voltage Adjust Upwards, Increase:

 $\left(\frac{5.11 \times 5.0(100 + \Delta\%)}{5.11 \times 5.0(100 + \Delta\%)} - \frac{511}{5.10} - 10.22\right)$ kΩ Radj = $1.225 \times \Delta\%$ $\Delta\%$ Example: Increase 4% =>V_o = 5.2 Vdc $\left(\frac{5.11 \times 5.0(100 + 4)}{1.225 \times 4} - \frac{511}{4} - 10.22\right) \text{ k}\Omega = 404 \text{ k}\Omega$

Active adjust

The output voltage may be adjusted using a voltage applied to the Vadj pin. This voltage is calculated by using the following equations:

$$V_{adj} = \left(1.225 + 2.45 \times \frac{V_{desired} - 5.0}{5.0}\right) V$$

Example: Upwards => 5.2 V

$$\left(1.225 + 2.45 \times \frac{5.2 - 5.0}{5.0}\right) V = 1.323 V$$

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12 V/2.75 A Electrical Specification

 T_{P1} = -30 to +90°C, V_I = 18 to 72 V, unless otherwise specified under Conditions. Typical values given at: T_{P1} = +25°C, V_I= 53 V_I max I_o, unless otherwise specified under Conditions. Additional C_o = 47 μ F.

Chara	cteristics	Conditions	min	typ	max	Unit
VI	Input voltage range		18		72	V
V _{loff}	Turn-off input voltage	Decreasing input voltage	15	16	17	V
V _{Ion}	Turn-on input voltage	Increasing input voltage	16	17	18	V
Cı	Internal input capacitance			4.4		μF
Po	Output power	Output voltage initial setting	0		33	W
	Efficiency	50 % of max I _{o,} , V _I = 27 V		88.8		- %
		max I _{O,} , V ₁ = 27 V		89.2		
η		50 % of max I _o , V _I = 53 V		85.6		
		max I _o , V _I = 53 V		88.0		
P _d	Power Dissipation	max I _o		4.8	8.2	W
Pli	Input idling power	I ₀ = 0 A, V ₁ = 53 V		2.2		W
P _{RC}	Input standby power	V ₁ = 53 V (turned off with RC)		0.4		W
f _s	Switching frequency	0-100 % of max I ₀	255	285	315	kHz

V_{Oi}	Output voltage initial setting and accuracy	T _{P1} = +25°C, V _I = 53 V, I _O = 2.75 A	11.76	12.0	12.24	V
	Output adjust range	See operating information	10.8		13.2	V
	Output voltage tolerance band	10-100 % of max I _o	11.64		12.36	V
Vo	Idling voltage	I ₀ = 0 A	11.76		12.24	V
	Line regulation	max I _o		±5	±50	mV
	Load regulation	V_{I} = 53 V, 0-100 % of max I_{O}		±5	±50	mV
V _{tr}	Load transient voltage deviation	V₁ = 53 V, Load step 25-75-25 % of max I₀, di/dt = 5 A/µs, C₀ = 275 µF		±400	±600	mV
t _{tr}	Load transient recovery time	$1000 \text{ max } 1_0, \text{ and } 1 = 5 \text{ Avps}, \text{ C}_0 = 275 \text{ pc}$		75	150	μs
t _r	Ramp-up time (from 10–90 % of V _{Oi})	10-100 % of max Io		5		ms
ts	Start-up time (from V_i connection to 90 % of V_{Oi})	10-100 /0 01 max 1 ₀		7		ms
t _f	V _I shut-down fall time	max I ₀	0.4	0.6		ms
ч	(from V_1 off to 10 % of V_0)	$I_{\rm O} = 0 \text{ A}$		1		S
	RC start-up time	max I _o		30		ms
t _{RC}	RC shut-down fall time (from RC off to 10 % of V _o)	max I _o	0.4	0.6		ms
		I ₀ = 0 A		0.7		S
lo	Output current		0		2.75	А
l _{lim}	Current limit threshold	$V_1 = 53 V, T_{P1} < max T_{P1}$		4.3	5.6	А
l _{sc}	Short circuit current	T _{P1} = 25°C, Note 1		8.6		Α
V _{Oac}	Output ripple & noise	See ripple & noise section, max I_0 , V_{0i} , C_0 = 47 μ F		25	50	mVp-p
OVP	Over voltage protection	T_{P1} = +25°C, V _I = 53 V, 0-100 % of max I ₀		16		V

PKU 5313E PI

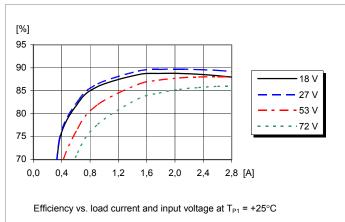
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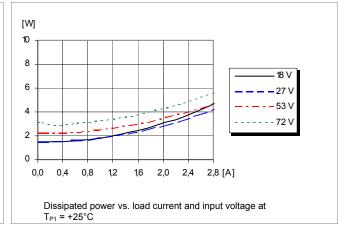
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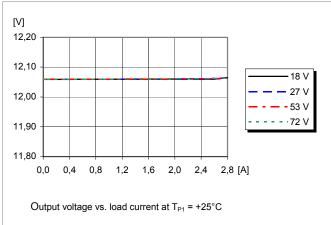
12 V/2.75 A Typical Characteristics

Efficiency



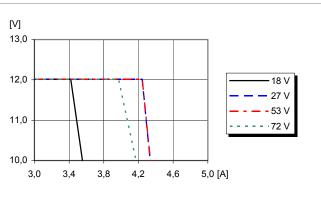


Output Characteristics



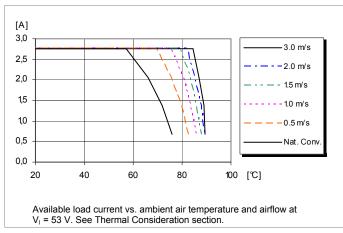
Current Limit Characteristics

Power Dissipation



Output voltage vs. load current at I_0 > max I_0 , T_{P1} = +25°C The module enters hiccup mode when the output current exceeds current limit.

Output Current Derating



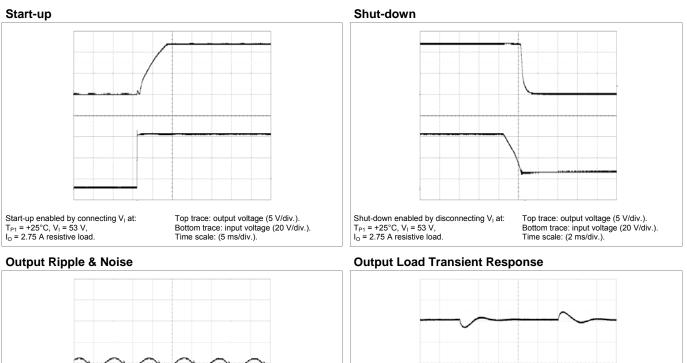
PKU 5313E PI

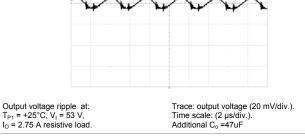
	lechnical Specification	13
PKU 5000E series	EN/LZT 146 391 R4B May 2009	
DC/DC converters, Input 18-72 V, Output up to 10 A/35 W	© Ericsson AB	

12 V/2.75 A Typical Characteristics

PKU 5313E PI

40





Output Voltage Adjust (see operating information)

Passive adjust

The resistor value for an adjusted output voltage is calculated by using the following equations:

```
Output Voltage Adjust Upwards, Increase:
```

$$Radj = \left(\frac{5.11 \times 12.0(100 + \Delta\%)}{1.225 \times \Delta\%} - \frac{511}{\Delta\%} - 10.22\right) k\Omega$$

 $\begin{array}{l} \mbox{Example: Increase 4\% =>V_{out} = 12.48 \ Vdc} \\ \left(\frac{5.11 \times 12.0 (100 + 4)}{1.225 \times 4} - \frac{511}{4} - 10.22 \right) \ \mbox{$k\Omega$ = 1174 $k\Omega$} \end{array}$

Active adjust

The output voltage may be adjusted using a voltage applied to the Vadj pin. This voltage is calculated by using the following equations:

Top trace: output voltage (1 V/div.). Bottom trace: load current (2 A/div.). Time scale: (0.5 ms/div.).

$$V_{adj} = \left(1.225 + 2.45 \times \frac{V_{desired} - 12.0}{12.0}\right) V$$

Output voltage response to load current stepchange (0.7-2.1-0.7 A) at: T_{P1} =+25°C, V_I = 53 V, C_o = 275 μF

$$\left(1.225 + 2.45 \times \frac{12.48 - 12.0}{12.0}\right)$$
 V = 1.323 V

Technical Specification

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DC/DC converters, Input 18-72 V, Output up to 10 A/35 W

15 V/2 A Electrical Specification

 T_{P1} = -30 to +90°C, V_I = 18 to 72 V, unless otherwise specified under Conditions. Typical values given at: T_{P1} = +25°C, V_I= 53 V_I max I₀, unless otherwise specified under Conditions. Additional C₀ = 47 μ F.

Chara	cteristics	Conditions	min	typ	max	Unit
VI	Input voltage range		18		72	V
V _{loff}	Turn-off input voltage	Decreasing input voltage	15	16	17	V
Vlon	Turn-on input voltage	Increasing input voltage	16	17	18	V
Cı	Internal input capacitance			4.4		μF
Po	Output power	Output voltage initial setting	0		30	W
	Efficiency	50 % of max I _{O,} , V _I = 27 V		85.6		%
n		max I _{O,} , V _I = 27 V		89.0		
Ч		50 % of max I _o , V _I = 53 V		80.9		
		max I _o , V _I = 53 V		86.7		
P _d	Power Dissipation	max I _o		4.6	8	W
Pli	Input idling power	I ₀ = 0 A, V ₁ = 53 V		3.2		W
P _{RC}	Input standby power	V ₁ = 53 V (turned off with RC)		0.4		W
f _s	Switching frequency	0-100 % of max I ₀	280	315	350	kHz

V _{Oi}	Output voltage initial setting and accuracy	T _{P1} = +25°C, V _I = 53 V, I _O = 2 A	14.70	15.0	15.30	V
	Output adjust range	See operating information, Note 1	13.5		16.5	V
	Output voltage tolerance band	10-100 % of max I _o	14.70		15.30	V
Vo	Idling voltage	I _O = 0 A	14.70		15.30	V
	Line regulation	max I _o		±50	±100	mV
	Load regulation	$V_1 = 53 V$, 0-100 % of max I_0		±50	±100	mV
V _{tr}	Load transient voltage deviation	$V_1 = 53 V$, Load step 25-75-25 % of		±300	±500	mV
t _{tr}	Load transient recovery time	max I _o , di/dt = 5 A/ μ s, C _o = 200 μ F		150	250	μs
t _r	Ramp-up time (from 10-90 % of V _{Oi})	10-100 % of max lo		5		ms
ts	Start-up time (from V ₁ connection to 90 % of V _{Oi})			6		ms
t _f	V _I shut-down fall time	max I _o	1	3		ms
ч	(from V_1 off to 10 % of V_0)	$I_{O} = 0 A$		1		S
	RC start-up time	max I _o		28		ms
t _{RC}	RC shut-down fall time (from RC off to 10 % of V _o)	max I _o	1	2		ms
		I ₀ = 0 A		0.5		S
lo	Output current		0		2	Α
l _{lim}	Current limit threshold	$V_{I} = 53 V, T_{P1} < max T_{P1}$		3.2	5	Α
I _{sc}	Short circuit current	T _{P1} = 25°C, Note 2		6		Α
V_{Oac}	Output ripple & noise	See ripple & noise section, max I_0 , V_{0i} , C_0 = 47uF		25	50	mVp-p
OVP	Over voltage protection	T_{P1} = +25°C, V _I = 53 V, 0-100 % of max I ₀		19		V

1) V₁ min 24 V to obtain 16.5 V at 30 W output power.

2) RMS value

PKU 5315E PI

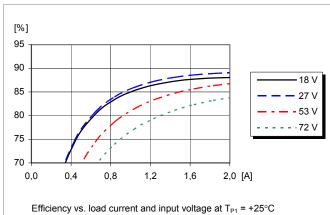
DC/DC converters, Input 18-72 V, Output up to 10 A/35 W

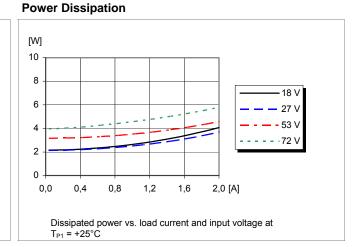
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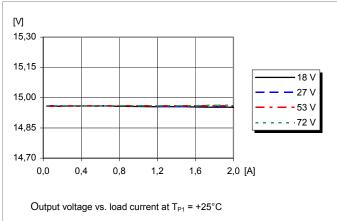
15 V/2 A Typical Characteristics

Efficiency

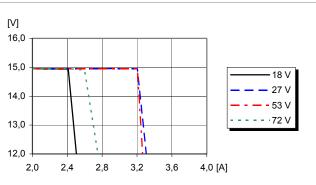




Output Characteristics

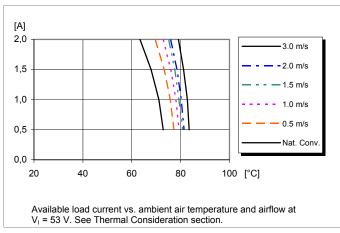


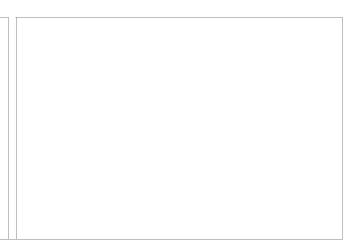




Output voltage vs. load current at $I_O > max I_O$, $T_{P1} = +25^{\circ}C$ The module enters hiccup mode when the output current exceeds current limit.

Output Current Derating





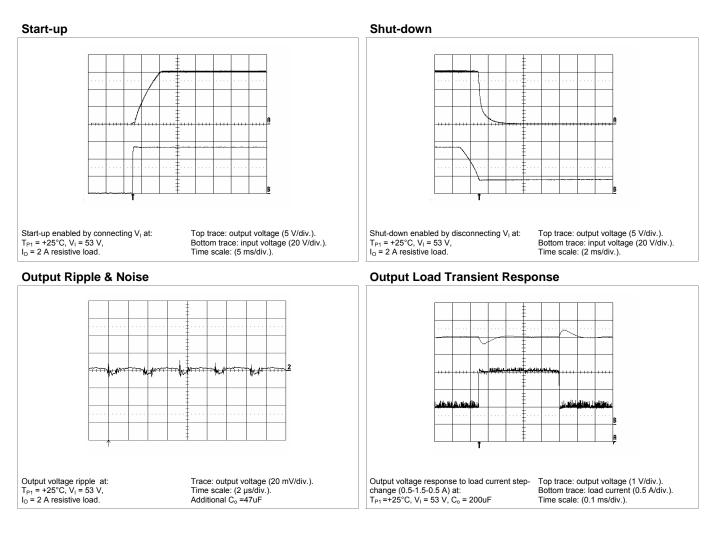
PKU 5315E PI



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15 V/2 A Typical Characteristics

PKU 5315E PI



Output Voltage Adjust (see operating information)

Passive adjust

The resistor value for an adjusted output voltage is calculated by using the following equations:

```
Output Voltage Adjust Upwards, Increase:
```

$$Radj = \left(\frac{5.11 \times 15.0(100 + \Delta\%)}{1.225 \times \Delta\%} - \frac{511}{\Delta\%} - 10.22\right) k\Omega$$

 $\begin{array}{l} \mbox{Example: Increase 4\% =>V_{out} = 15.6 \ Vdc} \\ \left(\frac{5.11 \times 15.0 (100 + 4)}{1.225 \times 4} - \frac{511}{4} - 10.22 \right) \ \mbox{$k\Omega$ = 1489 \ $k\Omega$} \end{array}$

Active adjust

The output voltage may be adjusted using a voltage applied to the Vadj pin. This voltage is calculated by using the following equations:

$$V_{adj} = \left(1.225 + 2.45 \times \frac{V_{desired} - 15.0}{15.0}\right) V$$

Example: Upwards => 15.6 V

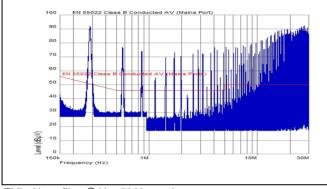
$$\left(1.225 + 2.45 \times \frac{15.6 - 15.0}{15.0}\right) V = 1.323 V$$

DC/DC converters, Input 18-72 V, Output up to 10 A/35 W

EMC Specification

Conducted EMI measured according to EN55022, CISPR 22 and FCC part 15J (see test set-up). See Design Note 009 for further information. The fundamental switching frequency is 285 kHz for PKU 5310E PI, PKU 5311E PI, and PKU 5313E PI. For PKU 5315E PI it is 315 kHz.

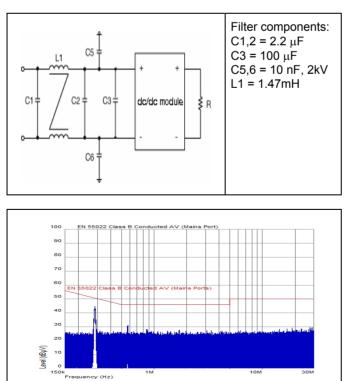
Conducted EMI Input terminal value (typ)



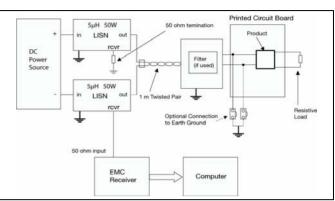
EMI without filter @ $V_1 = 53$ V, max I_0 .

External filter (class B)

Required external input filter in order to meet class B in EN 55022, CISPR 22 and FCC part 15J.



EMI with filter @ $V_1 = 53$ V, max I_0 .



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Test set-up

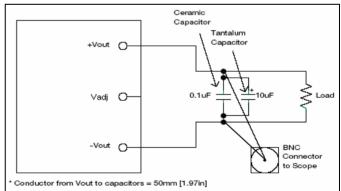
Layout recommendations

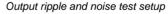
The radiated EMI performance of the Product will depend on the PCB layout and ground layer design. It is also important to consider the stand-off of the product. If a ground layer is used, it should be connected to the output of the product and the equipment ground or chassis.

A ground layer will increase the stray capacitance in the PCB and improve the high frequency EMC performance.

Output ripple and noise

Output ripple and noise measured according to figure below. See Design Note 022 for detailed information.





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DC/DC converters, Input 18-72 V, Output up to 10 A/35 W	© Ericsson AB	

Operating information

Input Voltage

The input voltage range 18 to 72Vdc meets the requirements of the European Telecom Standard ETS 300 132-2 for normal input voltage range in -48 and -60 Vdc systems, -40.5 to -57.0 V and -50.0 to -72 V respectively.

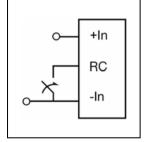
At input voltages exceeding 72 V, the power loss will be higher than at normal input voltage. Precaution must be taken to keep T_{P1} below +95°C. The absolute maximum continuous input voltage is 80 Vdc.

Turn-off Input Voltage

The products monitor the input voltage and will turn on and turn off at predetermined levels.

The minimum hysteresis between turn on and turn off input voltage is 1V. The input voltage supply must have low impedance to prevent the risk of input oscillation, poor supply can also cause shutdown-bouncing.

Remote Control (RC)



The products are fitted with a remote control function referenced to the primary negative input connection (-In), with negative and positive logic options available. The RC function allows the product to be turned on/off by an external device like a semiconductor or mechanical switch. The RC pin has an internal pull up resistor to +In.

The maximum required sink current is 1 mA. When the RC pin is left open, the voltage generated on the RC pin is 4.5 - 5.5 V.

The standard product is provided with "negative logic" remote control and will be off until the RC pin is connected to the -In. To turn on the product the voltage between RC pin and -In should be less than 1V.

To turn off the converter the RC pin should be left open, or connected to a voltage higher than 4 V referenced to -In. In situations where it is desired to have the product to power up automatically without the need for control signals or a switch, the RC pin can be wired directly to -In.

The second option is "positive logic" remote control, which can be ordered by adding the suffix "P" to the end of the part number.

When the RC pin is left open, the product starts up automatically when the input voltage is applied. Turn off is achieved by connecting the RC pin to the -In. To ensure safe turn off the voltage difference between RC pin and the -In pin shall be less than 1V. The product will restart automatically when this connection is opened.

Input and Output Impedance

The impedance of both the input source and the load will interact with the impedance of the DC/DC converter. It is important that the input source has low characteristic impedance.

The performance in some applications can be enhanced by addition of external capacitance as described in External Decoupling Capacitors.

If the input voltage source contains significant inductance, the addition of a low ESR 47 μ F capacitor across the input of the converter will ensure stable operation in all conditions.

External Decoupling Capacitors

The products have been designed to operate with a minimum capacitance connected to their output.

When powering loads with significant dynamic current requirements, the voltage regulation at the point of load can be improved by addition of decoupling capacitors at the load. The most effective technique is to locate low ESR ceramic and electrolytic capacitors as close to the load as possible, using several parallel capacitors to lower the effective ESR. The ceramic capacitors will handle high-frequency dynamic load changes while the electrolytic capacitors are used to handle low frequency dynamic load changes. Ceramic capacitors will also reduce any high frequency noise at the load.

It is equally important to use low resistance and low inductance PCB layouts and cabling. If significant inductance are within the load distribution, >50% of the stated "Minimum Output Capacitance" shall be located at the module's output.

External decoupling capacitors will become part of the control loop of the DC/DC converter and may affect the stability margins. As a "rule of thumb", 100 μ F/A of output current can be added without any additional analysis. The ESR of the capacitors is a very important parameter. Ericsson Power Modules guarantee stable operation with a verified ESR value of >10 m Ω across the output connections.

	Minimum Input Capacitance	Minimum Output Capacitance		
PKU 5310E PI	47uF	220uF		
PKU 5311E PI	47uF	150uF		
PKU 5313E PI	47uF	47uF		
PKU 5315E PI	47uF	47uF		
Minimum capacitance				

For further information please contact your local Ericsson Power Modules representative.

See Design Note 021 for detailed information.

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Operating information continued

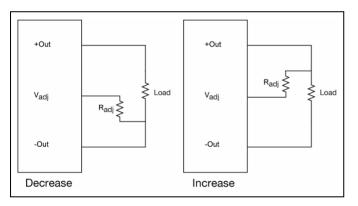
Output Voltage Adjust (Vadj)

The products have an Output Voltage Adjust pin (V_{adj}). This pin can be used to adjust the output voltage above or below Output voltage initial setting.

When increasing the output voltage, the voltage at the output pins must be kept below the threshold of the over voltage protection, (OVP) to prevent the product from entering OVP. At increased output voltages the maximum power rating of the product remains the same, and the max output current must be decreased correspondingly.

To increase the voltage the resistor should be connected between the V_{adj} pin and +Out pin. The resistor value of the Output voltage adjust function is according to information given under the Output section for the respective product.

To decrease the output voltage, the resistor should be connected between the V_{adj} pin and –Out pin.



Over Temperature Protection (OTP)

The converters are protected from thermal overload by an internal over temperature shutdown circuit.

When $T_{P1}\,$ as defined in thermal consideration section reach exceeds 105°C the converter will shut down.

The DC/DC converter will make continuous attempts to start up (non-latching mode) and resume normal operation automatically when the hot-spot temperature has dropped 10°C below the temperature threshold.

Over Voltage Protection (OVP)

The converters have output over voltage protection that will prevent output voltage to exceed the specified value in technical specification.

The converter will limit the outputvoltage to the maximum level. Converters will resume normal operation automatically after removal of the over voltage condition.

Over Current Protection (OCP)

The converters include current limiting circuitry for protection at continuous overload.

The output voltage will decrease towards zero for output currents in excess of max output current (max I_0).

After a time period exceeding 10 ms in OCP converters will enter hiccupmode to reduce average output power.

During short-circuit condition module temperature will increase rapidly and OTP function may be activated.

Module will not resume from hiccup shutdown period unless the temperature drops below the OTP re-activation temperature.

The converter will resume normal operation after removal of the overload. The load distribution should be designed for the maximum output short circuit current specified.

Pre-bias Start-up

The product has a Pre-bias start up functionality and will not sink current during start up or RC-off if a pre-bias source with less than 75% of V_o is present at the output terminals.

Precaution must be taken that reverse current might be present if V_i is disabled. Without V_i a small current will discharge external capacitors.

NB! Feeding V_o from external power supply for test purpose might without V_i cause high reverse current.

DC/DC converters, Input 18-72 V, Output up to 10 A/35 W

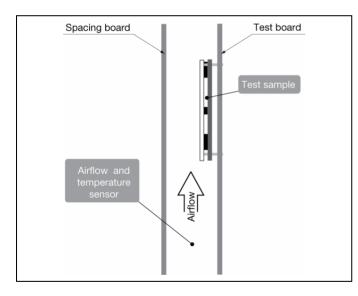
Thermal Consideration

General

The products are designed to operate in different thermal environments and sufficient cooling must be provided to ensure reliable operation.

For products mounted on a PCB without a heat sink attached, cooling is achieved mainly by conduction, from the pins to the host board, and convection, which is dependant on the airflow across the product. Increased airflow enhances the cooling of the product. The Output Current Derating graph found in the Output section for each model provides the available output current vs. ambient air temperature and air velocity at $V_1 = 53 \text{ V}$.

The product is tested on a 254 x 254 mm, 35 μ m (1 oz), 8-layer test board mounted vertically in a wind tunnel with a cross-section of 608 x 203 mm.

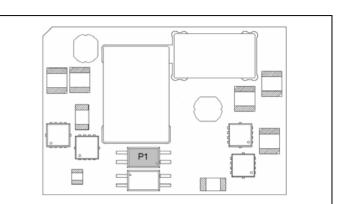


Proper cooling of the product can be verified by measuring the temperature at position P1. The temperature at this position should not exceed the max values provided in the table below. The number of points may vary with different thermal design and topology.

See Design Note 019 for further information.

Position	Description	Temp. limit
P1	Opto coupler	95° C

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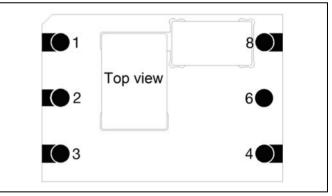
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Open frame

Definition of reference temperature T_{P1}

The reference temperature is used to monitor the temperature limits of the product. Temperatures above maximum T_{P1} , meassured at the reference point P1 are not allowed and may cause degradation or permanent damage to the product. T_{P1} is also used to define the temperature range for normal operating conditions. T_{P1} is defined by the design and used to guarantee safety margins, proper operation and high reliability ot the product.

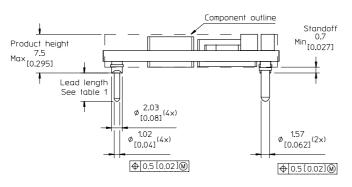
Connections

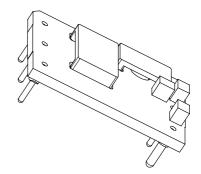


Pin	Designation	Function
1	+In	Positive Input
2	RC	Remote control
3	-In	Negative Input
4	-Out	Negative Output
6	Vadj	Output voltage adjust
8	+Out	Positive Output

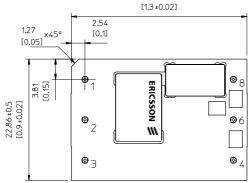
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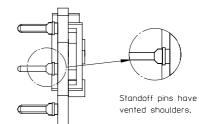
Mechanical Information - Hole Mount, Open Frame Version

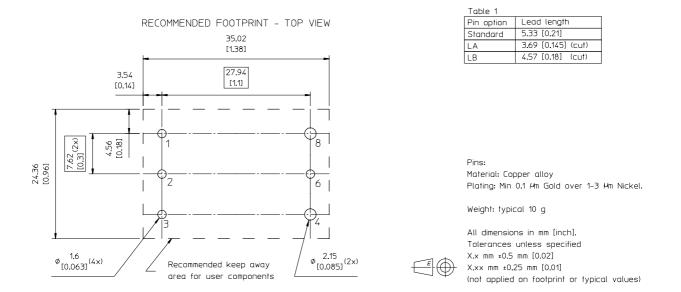




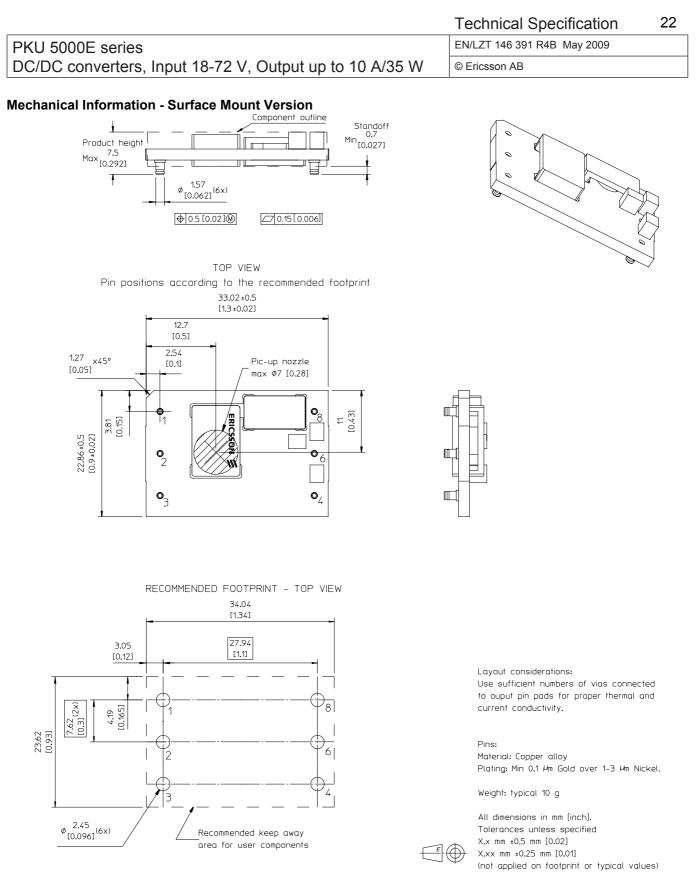
TOP VIEW Pin positions according to the recommended footprint. \$33.02 ± 0.5







All component placements – whether shown as physical components or symbolical outline – are for reference only and are subject to change throughout the product's life cycle, unless explicitly described and dimensioned in this drawing.



All component placements – whether shown as physical components or symbolical outline – are for reference only and are subject to change throughout the product's life cycle, unless explicitly described and dimensioned in this drawing.

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Soldering Information - Surface Mounting

The surface mount product is intended for forced convection or vapor phase reflow soldering in SnPb or Pb-free processes.

The reflow profile should be optimised to avoid excessive heating of the product. It is recommended to have a sufficiently extended preheat time to ensure an even temperature across the host PCB and it is also recommended to minimize the time in reflow.

A no-clean flux is recommended to avoid entrapment of cleaning fluids in cavities inside the product or between the product and the host board, since cleaning residues may affect long time reliability and isolation voltage.

Minimum Pin Temperature Recommendations

Pin number 8 is chosen as reference location for the minimum pin temperature recommendation since this will likely be the coolest solder joint during the reflow process.

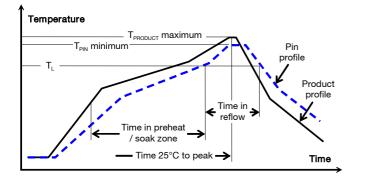
SnPb solder processes

For SnPb solder processes, a pin temperature (T_{PIN}) in excess of the solder melting temperature, (T_L , 183°C for Sn63Pb37) for more than 30 seconds and a peak temperature of 210°C is recommended to ensure a reliable solder joint.

Lead-free (Pb-free) solder processes

For Pb-free solder processes, a pin temperature (T_{PIN}) in excess of the solder melting temperature (T_L, 217 to 221°C for SnAgCu solder alloys) for more than 30 seconds and a peak temperature of 235°C on all solder joints is recommended to ensure a reliable solder joint.

General reflow process specifications		SnPb eutectic	Pb-free
Average ramp-up (T _{PRODUCT})		3°C/s max	3°C/s max
Typical solder melting (liquidus) temperature	TL	183°C	221°C
Minimum reflow time above T_L		30 s	30 s
Minimum pin temperature	T _{PIN}	210°C	235°C
Max product temperature	TPRODUCT	225°C	260°C
Average ramp-down (T _{PRODUCT})		6°C/s max	6°C/s max
Maximum time 25°C to peak		6 minutes	8 minutes



Maximum Product Temperature Requirements

Top of the product PCB near pin 2 is chosen as reference location for the maximum (peak) allowed product temperature ($T_{PRODUCT}$) since this will likely be the warmest part of the product during the reflow process.

SnPb solder processes

For SnPb solder processes, the product is qualified for MSL 1 according to IPC/JEDEC standard J-STD-020C.

During reflow T_{PRODUCT} must not exceed 225 °C at any time.

Pb-free solder processes

For Pb-free solder processes, the product is qualified for MSL 3 according to IPC/JEDEC standard J-STD-020C.

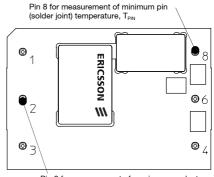
During reflow T_{PRODUCT} must not exceed 260 °C at any time.

Dry Pack Information

Products intended for Pb-free reflow soldering processes are delivered in standard moisture barrier bags according to IPC/JEDEC standard J-STD-033 (Handling, packing, shipping and use of moisture/reflow sensitivity surface mount devices).

Using products in high temperature Pb-free soldering processes requires dry pack storage and handling. In case the products have been stored in an uncontrolled environment and no longer can be considered dry, the modules must be baked according to J-STD-033.

Thermocoupler Attachment



Pin 2 for measurement of maximum product temperature, TPRODUCT

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Soldering Information - Hole Mounting

The hole mounted product is intended for plated through hole mounting by wave or manual soldering. The pin temperature is specified to maximum to 270°C for maximum 10 seconds.

A maximum preheat rate of 4° C/s and maximum preheat temperature of 150° C is suggested. When soldering by hand, care should be taken to avoid direct contact between the hot soldering iron tip and the pins for more than a few seconds in order to prevent overheating.

A no-clean flux is recommended to avoid entrapment of cleaning fluids in cavities inside the product or between the product and the host board. The cleaning residues may affect long time reliability and isolation voltage.

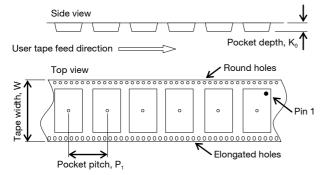
Delivery Package Information

The surface mount products are delivered in antistatic injection molded trays (Jedec design guide 4.10D standard) and in antistatic carrier tape (EIA 481 standard). The through-hole mount products are delivered in antistatic

injection molded trays (Jedec design guide 4.10D standard).

Carrier Tape Specifications			
Material	Antistatic PS		
Surface resistance	10 ⁷ < Ohm/square		
Bakeability	The tape is not bakable		
Tape width, W	56 mm [2.2 inch]		
Pocket pitch, P1	36 mm [1.42 inch]		
Pocket depth, K ₀	8.7 mm [0.343 inch]		
Reel diameter	380 mm [15 inch]		
Reel capacity	200 products /reel		
Reel weight	2.3 kg/full reel		

EIA standard carrier tape



 Tray Specifications

 Material
 Antistatic PPE

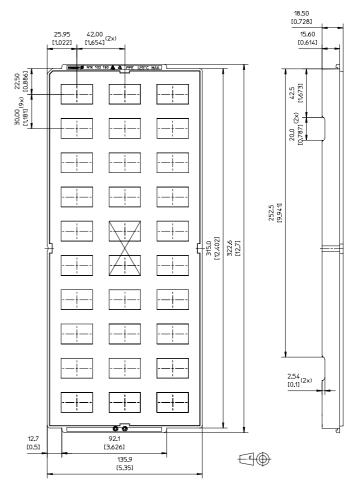
 Surface resistance
 10⁵ < Ohm/square < 10¹²

 Bakability
 The trays can be baked at maximum 125°C for 48 hours

 Tray thickness
 18.5 mm [0.728 inch]

 Tray capacity
 30 products/tray

 Tray weight
 190 g empty, 500 g full tray



X = Vacuum pick up

All dimensions in mm [inch] Tolerances: X.xx mm ±0.13 mm [0.005], X.x mm ±0.26 mm [0.01]

Note: tray dimensions refer to pocket center. For exact location of product pick up surface, refer to mechanical drawing.

PKU 5000E series

DC/DC converters, Input 18-72 V, Output up to 10 A/35 W

EN/LZT 146 391 R4B May 2009 © Ericsson AB

Product Qualification Specification

Characteristics	Characteristics					
External visual inspection	IPC-A-610					
Change of temperature (Temperature cycling)	IEC 60068-2-14 Na	Temperature range Number of cycles Dwell/transfer time	-40 to 100°C 1000 15 min/0-1 min			
Cold (in operation)	IEC 60068-2-1 Ad	Temperature T _A Duration	-45°C 72 h			
Damp heat	IEC 60068-2-67 Cy	Temperature Humidity Duration	85°C 85 % RH 1000 hours			
Dry heat	IEC 60068-2-2 Bd	Temperature Duration	125°C 1000 h			
Electrostatic discharge susceptibility	IEC 61340-3-1, JESD 22-A114 IEC 61340-3-2, JESD 22-A115	Human body model (HBM) Machine Model (MM)	Class 1C, 1000 V Class 3, 200 V			
Immersion in cleaning solvents	IEC 60068-2-45 XA, method 2	Water Glycol ether Isopropyl alcohol	55°C 35°C 35°C			
Mechanical shock	IEC 60068-2-27 Ea	Peak acceleration Duration	100 g 6 ms			
Moisture reflow sensitivity ¹	J-STD-020C	Level 1 (SnPb-eutectic) Level 3 (Pb Free)	225°C 260°C			
Operational life test	MIL-STD-202G, method 108A	Duration	1000 h			
Resistance to soldering heat ²	IEC 60068-2-20 Tb, method 1A	Solder temperature Duration	270°C 10-13 s			
Robustness of terminations	IEC 60068-2-21 Test Ua1 IEC 60068-2-21 Test Ue1	Through hole mount products Surface mount products	All leads All leads			
Solderability	IEC 60068-2-58 test Td ¹	Preconditioning Temperature, SnPb Eutectic Temperature, Pb-free	150°C dry bake 16 h 215°C 235°C			
	IEC 60068-2-20 test Ta ²	Preconditioning Temperature, SnPb Eutectic Temperature, Pb-free	Steam ageing 235°C 245°C			
Vibration, broad band random	IEC 60068-2-64 Fh, method 1	Frequency Spectral density Duration	10 to 500 Hz 0.07 g²/Hz 10 min in each direction			

Notes

¹ Only for products intended for reflow soldering (surface mount products)

² Only for products intended for wave soldering (plated through hole products)